

HSU227

Silicon Schottky Barrier Diode for High Speed Switching

HITACHI

ADE-208-779(Z)

Rev 0

Mar. 1999

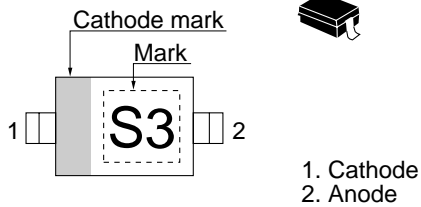
Features

- Low capacitance. (C=3.0pF max)
- Ultra small Resin Package (URP) is suitable for high density surface mounting and high speed assembly.

Ordering Information

Type No.	Laser Mark	Package Code
HSU227	S3	URP

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	25	V
Average rectified current	I_o	50	mA
Non-Repetitive peak forward surge current	I_{FSM}^{*2}	200	mA
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

Note: 1. 10msec sine wave 1 pulse

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Forward voltage	V_F	—	0.29	0.35	V	$I_F = 1mA$
Reverse current	I_R	—	0.3	2.0	μA	$V_R = 20V$
Capacitance	C	—	2.45	3.0	pF	$V_R = 1V, 1=1MHz$

Main Characteristic

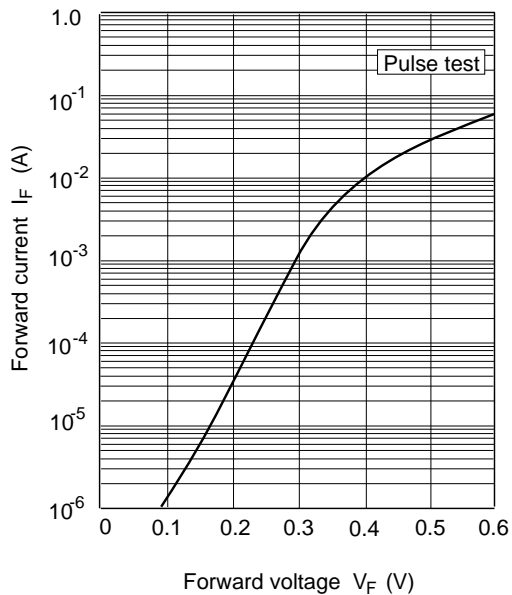


Fig.1 Forward current Vs. Forward voltage

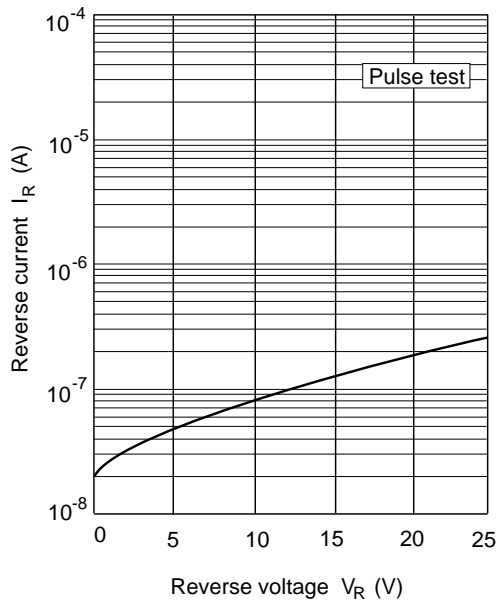


Fig.2 Reverse current Vs. Reverse voltage

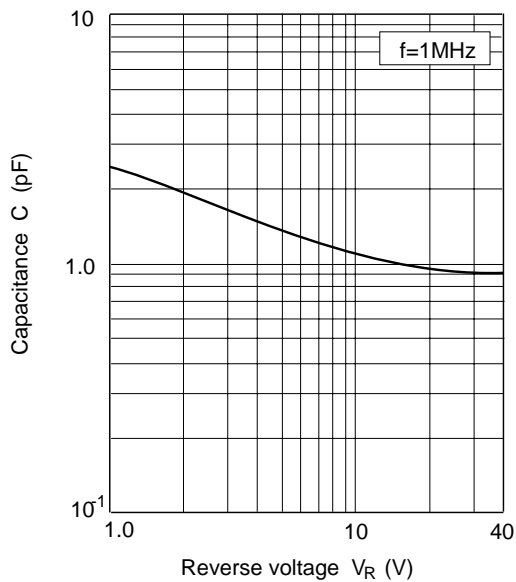
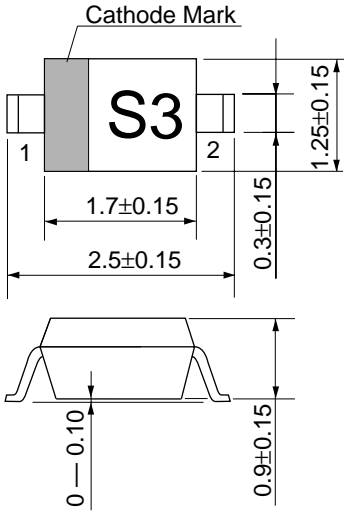


Fig.2 Capacitance Vs. Reverse voltage

Package Dimensions

Unit : mm



- 1. Cathode
- 2. Anode

Hitachi Code	URP
JEDECCode	—
EIAJCode	—
Weight(g)	0.004

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